

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KI HONG CHOI	06/01/2017
SEUNG SHIK SHIN	06/01/2017
KYUONG SIK CHIN	06/01/2017
RECEIVING PARTY DATA	
Name:	LOTTE ADVANCED MATERIALS CO., LTD.
Street Address:	334-27, YEOSUSANDAN-RO
Internal Address:	YEOSU-SI, JEOLLANAM-DO
City:	YEOSU-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	59616
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15533045
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	1224.269
NAME OF SUBMITTER:	MELISSA B. PENDLETON
SIGNATURE:	/Melissa B. Pendleton/
DATE SIGNED:	06/05/2017
Total Attachments: 4	
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RECORDATION FORM COVER SHEET
PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)
KI HONG CHOI
SEUNG SHIK SHIN
KYUONG SIK CHIN

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: Lotte Advanced Materials Co., Ltd.
Internal Address: _____

3. Nature of conveyance/Execution Date(s):
Execution Date(s) June 1, 2017

Assignment Merger
 Security Agreement Change of Name
 Joint Research Agreement
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other _____

Street Address: 334-27, Yeosusandan-ro
City: Yeosu-si
State: Jeollanam-do
Country: South Korea Zip: 59616

Additional name(s) & address(es) attached? Yes No

4. Application or patent number(s): This document is being filed together with a new application.
A. Patent Application No.(s)
15/533,045

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:
Name: Additon, Higgins & Pendleton, P.A.
Internal Address: _____
Street Address: 10706 Sikes Place, Suite 350
City: Charlotte
State: NC Zip: 28277-8202
Phone Number: 704-945-6700
Fax Number: 704-945-6735
Email Address: _____

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ _____

Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number _____
Authorized User Name _____

9. Signature: /Melissa B. Pendleton/ June 5, 2017
Signature Date
Melissa B. Pendleton
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 4

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

COMBINED DECLARATION AND ASSIGNMENT

WHEREAS, I, Ki Hong CHOI, a citizen of the Republic of Korea, with a mailing address of 56, Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; Seung Shik SHIN, a citizen of the Republic of Korea, with a mailing address of 56, Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; and Kyuong Sik CHIN, a citizen of the Republic of Korea, with a mailing address of 56, Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in *Polycarbonate Resin Composition and Molded Product Comprising Same*, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from an International Application filed on December 28, 2015, under Serial No. PCT/KR2015/014329; a Korean application filed on December 31, 2014, under Serial No. 10-2014-0195804; and a Korean application filed on December 21, 2015, under Serial No. 10-2015-0183279, all applications listed above being hereinafter referred to as the "APPLICATION"; and

WHEREAS, Lotte Advanced Materials Co., Ltd., a corporation of the Republic of Korea (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 334-27, Yeosusandan-ro, Yeosu-si, Jeollanam-do, Republic of Korea, has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in and to any and all Letters Patent that shall be granted with respect to

said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest—and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest—in and to said INVENTION and APPLICATION, in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to said ASSIGNEE or its representatives any facts known to me relating to

said INVENTION, to testify in any interference or legal proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

As the below named inventor, I hereby declare:

The application for United States Letters Patent being filed concurrently herewith was made or authorized to be made by me.

I believe that I am the original or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in the declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below:

June 1, 2017

최기홍
Ki Hong CHOI

6.1, 2017

신승식
Seung Shik SHIN

6.1, 2017

진경식
Kyuong Sik CHIN